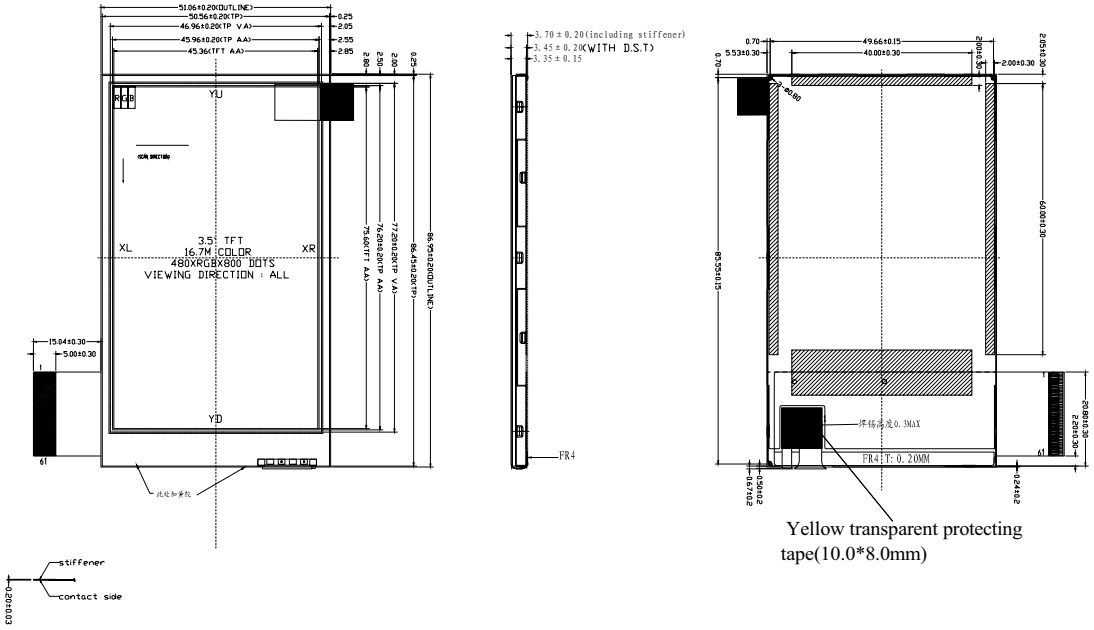
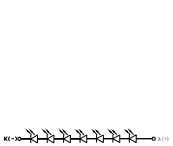
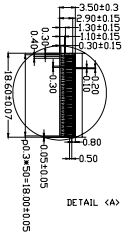


PIN DESCRIPTION

PIN	SYMBOL	PIN	SYMBOL
1	LED-	32	DB7
2	LED+	33	DB6
3	YU	34	DB5
4	XR	35	DB4
5	YD	36	DB3
6	XL	37	DB2
7	VDD2	38	DB1
8	VDD1	39	DB0
9	BLU_PWM	40	RDX_E
10	TE	41	WRX_DCX
11	DB0	42	DCX_SCL
12	DB1	43	CSX
13	DB2	44	SDI
14	DB3	45	SDO
15	RESX	46	VSYNC
16	DB23	47	HSYNC
17	DB22	48	DE
18	DB21	49	PCLK
19	DB20	50	DSI_LOD_ENB
20	DB19	51	DSI_VSS
21	DB18	52	DSI_DIN
22	DB17	53	DSI_DIP
23	DB16	54	DSI_VSS
24	DB15	55	DSI_CIN
25	DB14	56	DSI_CIP
26	DB13	57	DSI_VSS
27	DB12	58	DSI_D1N
28	DB11	59	DSI_D1P
29	DB10	60	DSI_VSS
30	DB9	61	VDD3
31	DB8		





NOTES:

1. DRIVE IC : HX8369-A01OPD250
2. TYPE : HFFS/WVGA/TFT
3. DISPLAY MODE : 16.7M Color LCD, Transmissive, Normal Black
4. BACKLIGHT: 7CHIP-WHITE LED, Serial connection
5. OPERATING TEMPERATURE: -10° C TO 60° C
   STORAGE TEMPERATURE: -20° C TO 70° C
6. RECOMNEND CONNECTOR: 196160-61041 (P-TWO)
7. MDS VA is the viewing area of the module. We recommend a 0.3mm gap between the edge of the case window and the MDS VA
   （MDS VA为模块VA区，建议机壳开窗比MDS VA单边小0.3mm）
8. C.A is the compressive area of the touch panel. It is suggested to be 0.2 mm away from the case cushion inner edge.
   （C.A为TP的可压区域，建议机壳泡棉内边至少要离开 C.A.内边0.2mm 以上
9. Please avoid any conductive material touching the corner or the edge of touch panel after mounting.
   （TP边缘不能接触导电体）
10. Please do not conduct hitting/slide tests surrounding the case. The effective area for hitting/slide tests is recommended to be at least 1.5mm away from the TP viewing area sides.
    （TP的VA单边往里偏1.5mm,为有效的划写区 ）
11. ROHS COMPLIANCY(符合ROHS要求)
12. GENERAL TOLERANCE : ±0.2

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